18-bit bus-interface D-type flip-flop with reset and enable; 3-state

Rev. 6 — 20 October 2020

Product data sheet

1. General description

The 74ALVT16823 is an 18-bit positive-edge triggered D-type flip-flop with 3-state outputs, reset and enable.

The device can be used as two 9-bit flip-flops or one 18-bit flip-flop. The device features clock (nCP), clock enable (nCE), master reset (nMR) and output enable (nOE, inputs each controlling 9-bits. When nCE is LOW, the flip-flops will store the state of their individual D-inputs that meet the set-up and hold time requirements on the LOW-to-HIGH clock (nCP) transition. A HIGH on nOE causes the outputs to assume a high-impedance OFF-state. Operation of the nOE input does not affect the state of the flip-flops. A LOW on nMR will reset the flip-flops LOW. Bus hold data inputs eliminate the need for external pull-up resistors to define unused inputs

2. Features and benefits

- Wide supply voltage range from 2.3 V to 3.6 V
- Overvoltage tolerant inputs to 5.5 V
- BiCMOS high speed and output drive
- Direct interface with TTL levels
- Bus hold on data inputs
- Power-up 3-state
- IOFF circuitry provides partial Power-down mode operation
- · Two sets of high speed parallel registers with positive edge-triggered D-type flip-flops
- Ideal where high speed, light loading, or increased fan-in are required with MOS microprocessors
- Live insertion and extraction permitted
- Power-up reset
- No bus current loading when output is tied to 5 V bus
- Output capability: +64 mA to -32 mA
- Latch-up performance exceeds 500 mA per JESD 78 Class II Level B
- ESD protection:
 - MIL STD 883, method 3015: exceeds 2000 V
 - MM: exceeds 200 V
- Specified from -40 °C to 85 °C

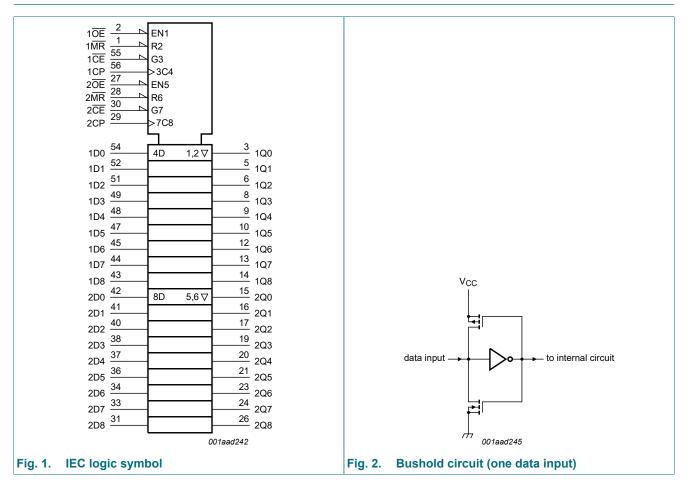
3. Ordering information

Table 1. Ordering information

Type number	Package	age						
	Temperature range	Name	Description	Version				
74ALVT16823DGG	-40 °C to +85 °C		plastic thin shrink small outline package; 56 leads; body width 6.1 mm	SOT364-1				

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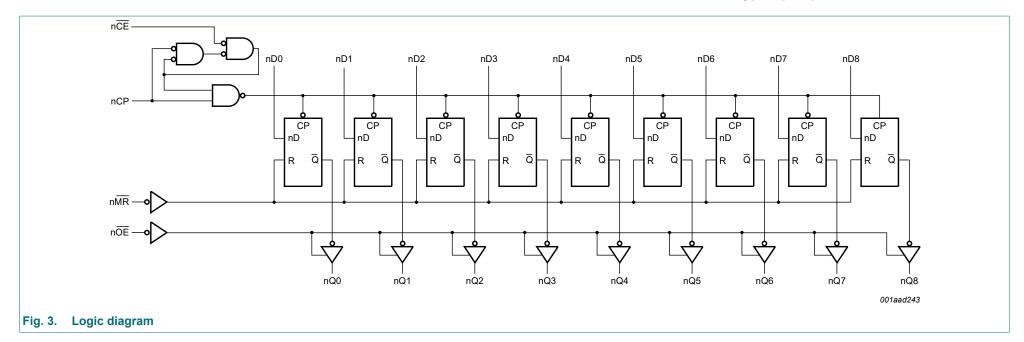
4. Functional diagram



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5. Pinning information

5.1. Pinning

1MR 1 56 1CP 10E 2 55 1CE 1Q0 3 54 1D0 GND 4 53 GND 1Q1 5 52 1D1 1Q2 6 51 1D2 V_{CC} 7 50 V_{CC} 1Q3 8 49 1D3 1Q4 9 48 1D4 1Q5 10 47 1D5 GND 11 46 GND 1Q6 12 45 1D6 1Q7 13 44 1D7 1Q8 14 43 1D8 74ALVT16823 42 2D0 2Q0 15 2Q1 16 41 2D1 2Q2 17 40 2D2 GND 18 39 GND 2Q3 19 38 2D3 2Q4 20 37 2D4 2Q5 21 36 2D5 V_{CC} 22 35 V_{CC} 2Q6 23 34 2D6 2Q7 24 33 2D7 GND 25 32 GND 2Q8 26 31 2D8 20E 27 30 2CE 2MR 28 29 2CP 001aad403 Fig. 4. Pin configuration SOT364-1 (TSSOP56)

5.2. Pin description

Table 2. Pin description

Symbol	Pin	Description
1D0, 1D1, 1D2, 1D3, 1D4, 1D5, 1D6, 1D7, 1D8	54, 52, 51, 49, 48, 47, 45, 44, 43	data inputs
1Q0, 1Q1, 1Q2, 1Q3, 1Q4, 1Q5, 1Q6, 1Q7, 1Q8	3, 5, 6, 8, 9, 10, 12, 13, 14	data outputs
2D0, 2D1, 2D2, 2D3, 2D4, 2D5, 2D6, 2D7, 2D8	42, 41, 40, 38, 37, 36, 34, 33, 31	data inputs
2Q0, 2Q1, 2Q2, 2Q3, 2Q4, 2Q5, 2Q6, 2Q7, 2Q8	15, 16, 17, 19, 20, 21, 23, 24, 26	data outputs
1MR, 2MR	1, 28	master reset input (active-LOW)
10E, 20E	2, 27	output enable inputs (active LOW)
1CP, 2CP	56, 29	clock pulse inputs (active rising edge)
1CE, 2CE	55, 30	clock enable input (active-LOW)
GND	4, 11, 18, 25, 32, 39, 46, 53	ground (0 V)
V _{CC}	7, 22, 35, 50	supply voltage

6. Functional description

Table 3. Function table

H = HIGH voltage level; h = HIGH voltage level one set-up time prior to the LOW-to-HIGH clock transition;

L = LOW voltage level; I = LOW voltage level one set-up time prior to the LOW-to-HIGH clock transition;

NC = no change; X = don't care; Z = high-impedance OFF-state;

↑ = LOW-to-HIGH clock transition; $\overline{\uparrow}$ = not a LOW-to-HIGH clock transition.

Operating mode	Input	put					
	n <mark>OE</mark>	nMR	nCE	nCP	nDn	nQn	
clear	L	L	Х	X	Х	L	
load and read data	L	Н	L	1	h	Н	
					I	L	
hold	L	Н	Н	Ť	Х	NC	
high-impedance	Н	Х	Х	Х	Х	Z	

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134); voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+4.6	V
VI	input voltage	[1]	-0.5	+7.0	V
Vo	output voltage	output in OFF-state or HIGH-state [1]	-0.5	+7.0	V
I _{IK}	input clamping current	V _I < 0 V	-	-50	mA
I _{ОК}	output clamping current	V _O < 0 V	-	-50	mA
I _O	output current	output in LOW-state	-	128	mA
		output in HIGH-state	-64	-	mA
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature	[2]	-	150	°C

[1] The input and output negative voltage ratings may be exceeded if the input and output clamp current ratings are observed.

[2] The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Table 5. Recommended operating conditions								
Symbol	Parameter	Conditions	Min	Тур	Мах	Unit		
V _{CC} = 2.5	5 V							
V _{CC}	supply voltage		2.3	-	2.7	V		
VI	input voltage		0	-	5.5	V		
I _{OH}	HIGH-level output current		-	-	-8	mA		
I _{OL}	LOW-level output current	none	-	-	8	mA		
		current duty cycle \leq 50 %; f \geq 1 kHz	-	-	24	mA		
Δt/Δv	input transition rise or fall rate	outputs enabled	-	-	10	ns/V		
T _{amb}	ambient temperature	in free air	-40	-	+85	°C		

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Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CC} = 3.3	3 V					-
V _{CC}	supply voltage		3.0	-	3.6	V
VI	input voltage		0	-	5.5	V
I _{OH}	HIGH-level output current		-	-	-32	mA
I _{OL}	LOW-level output current	none	-	-	32	mA
		current duty cycle ≤ 50 %; f ≥ 1 kHz	-	-	64	mA
Δt/Δv	input transition rise or fall rate	outputs enabled	-	-	10	ns/V
T _{amb}	ambient temperature	in free air	-40	-	+85	°C

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	T _{amb} =	−40 °C to	+85 °C	Unit
			Min	Typ[1]	Max	
V _{CC} = 2.	5 V ± 0.2 V					
V _{IK}	input clamping voltage	V _{CC} = 2.3 V; I _{IK} = -18 mA	-	-0.85	-1.2	V
V _{IH}	HIGH-level input voltage		1.7	-	-	V
V _{IL}	LOW-level input voltage		-	-	0.7	V
V _{OH}	HIGH-level output voltage	V_{CC} = 2.3 V to 2.7 V; I _O = -100 µA	V _{CC} - 0.2	V _{CC}	-	V
		V _{CC} = 2.3 V; I _O = -8 mA	1.8	2.5	-	V
V _{OL}	LOW-level output voltage	V _{CC} = 2.3 V; I _O = 100 μA	-	0.07	0.2	V
		V _{CC} = 2.3 V; I _O = 24 mA	-	0.3	0.5	V
		V _{CC} = 2.3 V; I _O = 8 mA	-	-	0.4	V
V _{OL(pu)}	power-up LOW-level output voltage	V_{CC} = 2.7 V; I _O = 1 mA; V _I = V _{CC} or GND	[2] -	-	0.55	V
lı	input leakage current	control pins				
		V_{CC} = 2.7 V; V_{I} = V_{CC} or GND	-	0.1	±1	μA
		$V_{CC} = 0 V \text{ to } 2.7 V; V_{I} = 5.5 V$	-	0.1	10	μA
		I/O data pins	[3]			
		$V_{CC} = 2.7 \text{ V}; \text{ V}_{I} = \text{V}_{CC}$	-	0.1	1	μA
		V _{CC} = 2.7 V; V _I = 0 V	-	+0.1	-5	μA
I _{OFF}	power-off leakage current	V_{CC} = 0 V; V _I or V _O = 0 V to 4.5 V	-	+0.1	±100	μA
I _{BHL}	bus hold LOW current	data inputs; V_{CC} = 2.3 V; V_{I} = 0.7 V	[4] -	100	-	μA
I _{BHH}	bus hold HIGH current	data inputs; V_{CC} = 2.3 V; V_{I} = 1.7 V	[4] -	-70	-	μA
I _{EX}	external current	output HIGH-state when $V_O > V_{CC}$; $V_O = 5.5 V$; $V_{CC} = 2.3 V$	-	10	125	μA
I _{O(pu\pd)}	power-up/power-down output current	$V_{CC} \le 1.2 \text{ V}; V_0 = 0.5 \text{ V to } V_{CC};$ V _I = GND or V _{CC}	[5] -	1	±100	μA
l _{oz}	OFF-state output current	V_{CC} = 2.7 V; V_{I} = V_{IL} or V_{IH}				
		output HIGH state; V _O = 2.3 V	-	0.5	5	μA
		output LOW-state; V _O = 0.5 V	-	+0.5	-5	μA

Symbol	Parameter	Conditions		T _{amb} =	−40 °C to	+85 °C	Unit
				Min	Typ <mark>[1]</mark>	Мах	
I _{CC}	supply current	V_{CC} = 2.7 V; V_{I} = GND or V_{CC} ; I_{O} = 0 A					
		outputs HIGH-state		-	0.04	0.1	mA
		outputs LOW-state		-	2.7	4.5	mA
		outputs disabled	[6]	-	0.04	0.1	mA
ΔI _{CC}	additional supply current	per input pin; V_{CC} = 2.3 V to 2.7 V; [7] one input at V_{CC} - 0.6 V, other inputs at V_{CC} or GND		-	0.04	0.4	mA
CI	input capacitance	$V_{I} = 0 V \text{ or } V_{CC}$		-	3	-	pF
Co	output capacitance	V _{I/O} = 0 V or 3.0 V		-	9	-	pF
V _{CC} = 3.	3 V ± 0.3 V						_
VIK	input clamping voltage	V _{CC} = 3.0 V; I _{IK} = -18 mA		-	-0.85	-1.2	V
V _{IH}	HIGH-level input voltage			2.0	-	-	V
VIL	LOW-level input voltage			-	-	0.8	V
V _{OH}	HIGH-level output voltage	V _{CC} = 3.0 V to 3.6 V; I _O = -100 μA	١	√ _{CC} - 0.2	V _{CC}	-	V
		V _{CC} = 3.0 V; I _O = -32 mA		2.0	2.3	-	V
V _{OL}	LOW-level output voltage	V _{CC} = 3.0 V; I _O = 100 μA		-	0.07	0.2	V
		V _{CC} = 3.0 V; I _O = 16 mA		-	0.25	0.4	V
		V _{CC} = 3.0 V; I _O = 32 mA		-	0.3	0.5	V
		V _{CC} = 3.0 V; I _O = 64 mA		-	0.4	0.55	V
V _{OL(pu)}	power-up LOW-level output voltage	$V_{CC} = 3.6 \text{ V}; I_0 = 1 \text{ mA}; V_1 = V_{CC} \text{ or GND}$	[2]	-	-	0.55	V
I _I	input leakage current	control pins					
		V_{CC} = 3.6 V; V_{I} = V_{CC} or GND		-	0.1	±1	μA
		V _{CC} = 0 V or 3.6 V; V _I = 5.5 V		-	0.1	10	μA
		I/O data pins	[3]				
		$V_{CC} = 3.6 V; V_{I} = V_{CC}$		-	0.5	1	μA
		V _{CC} = 3.6 V; V _I = 0 V		-	+0.1	-5	μA
I _{OFF}	power-off leakage current	$V_{CC} = 0 V$; V_{I} or $V_{O} = 0 V$ to 4.5 V		-	0.1	±100	μA
I _{BHL}	bus hold LOW current	data inputs; V_{CC} = 3 V; V_{I} = 0.8 V		75	130	-	μA
I _{BHH}	bus hold HIGH current	data inputs; V_{CC} = 3 V; V_{I} = 2.0 V		-75	-140	-	μA
I _{BHLO}	bus hold LOW overdrive current	data inputs; V_{CC} = 3.6 V; V_{I} = 0 V to 3.6 V	[8]	500	-	-	μA
I _{BHHO}	bus hold HIGH overdrive current	data inputs; V_{CC} = 3.6 V; V_{I} = 0 V to 3.6 V	[8]	-500	-	-	μA
I _{EX}	external current	output HIGH-state when V _O > V _{CC} ; V _O = 5.5 V; V _{CC} = 3.0 V		-	10	125	μA
I _{O(pu\pd)}	power-up/power-down output current	$V_{CC} \le 1.2 \text{ V}; V_0 = 0.5 \text{ V to } V_{CC};$ V _I = GND or V _{CC}	[9]	-	1	±100	μA
l _{oz}	OFF-state output current	$V_{CC} = 3.6 \text{ V}; \text{ V}_{I} = \text{V}_{IL} \text{ or } \text{V}_{IH}$					1
		output HIGH state; $V_0 = 3.0 V$		-	0.5	5	μA
		output LOW-state; V _O = 0.5 V		-	+0.5	-5	μA

Symbol	ymbol Parameter Conditions		T _{amb} =	-40 °C to	+85 °C	Unit
			Min	Typ[1]	Max	7
I _{CC}	supply current	V_{CC} = 3.6 V; V_{I} = GND or V_{CC} ; I_{O} = 0 A				
		outputs HIGH-state	-	0.06	0.1	mA
		outputs LOW-state	-	3.9	5.5	mA
		outputs disabled [6]	-	0.06	0.1	mA
ΔI _{CC}	additional supply current	per input pin; V_{CC} = 3 V to 3.6 V; [7] one input at V_{CC} - 0.6 V, other inputs at V_{CC} or GND	-	0.04	0.4	mA
CI	input capacitance	V _I = 0 V or V _{CC}	-	3	-	pF
Co	output capacitance	V _{I/O} = 0 V or 3.0 V	-	9	-	pF

[1] All typical values for V_{CC} = 2.5 V \pm 0.2 V are measured at V_{CC} = 2.5 V and T_{amb} = 25 °C.

All typical values for V_{CC} = 3.3 V \pm 0.3 V are measured at V_{CC} = 3.3 V and T_{amb} = 25 °C.

[2] For valid test results, data must not be loaded into the flip-flops after applying power.

 $[3] Unused pins at V_{CC} or GND.$

[4] Not guaranteed.

[5] This parameter is valid for any V_{CC} between 0 V and 1.2 V with a transition time of up to 10 ms.

From V_{CC} = 1.2 V to V_{CC} = 2.5 V ± 0.2 V a transition time of 100 µs is permitted. This parameter is valid for T_{amb} = 25 °C only.

[6] I_{CC} is measured with outputs pulled up to V_{CC} or pulled down to ground.

[7] This is the increase in supply current for each input at the specified voltage level other than V_{CC} or GND.

[8] This is the bus hold overdrive current required to force the input to the opposite logic state.

[9] This parameter is valid for any V_{CC} between 0 V and 1.2 V with a transition time of up to 10 ms.

From V_{CC} = 1.2 V to V_{CC} = 3.3 V ± 0.3 V a transition time of 100 µs is permitted. This parameter is valid for T_{amb} = 25 °C only.

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); for test circuit see Fig. 9.

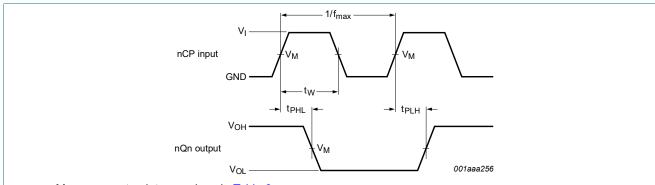
Symbol	Parameter	Conditions	T _{amb} =	= −40 °C to	+85 °C	Unit
			Min	Typ[1]	Max	
V _{CC} = 2.	5 V ± 0.2 V					_
t _{PLH}	LOW to HIGH propagation delay	nCP to nQn; see Fig. 5	1.5	2.9	4.5	ns
t _{PHL}	HIGH-to-LOW propagation delay	nCP to nQn; see Fig. 5	1.4	2.7	4.2	ns
		nMR to nQn; see <u>Fig. 7</u>	1.5	2.7	4.2	ns
t _{PZH}	OFF-state to HIGH propagation delay	nOE to nQn; see Fig. 8	2.1	3.4	5.0	ns
t _{PZL}	OFF-state to LOW propagation delay	nOE to nQn; see Fig. 8	1.8	3.0	4.7	ns
t _{PHZ}	HIGH to OFF-state propagation delay	nOE to nQn; see Fig. 8	1.7	3.0	4.3	ns
t _{PLZ}	LOW to OFF-state propagation delay	nOE to nQn; see Fig. 8	1.4	2.3	3.3	ns
t _{su(H)}	set-up time HIGH	nDn to nCP; see Fig. 6	1.0	0.5	-	ns
		nCE to nCP; see Fig. 6	1.0	0.2	-	ns
t _{su(L)}	set-up time LOW	nDn to nCP; see Fig. 6	1.8	1.3	-	ns
		nCE to nCP; see Fig. 6	0.5	-0.1	-	ns
t _{h(H)}	hold time HIGH	nDn to nCP; see Fig. 6	0.1	-1.4	-	ns
		nCE to nCP; see Fig. 6	1.0	0.2	-	ns
t _{h(L)}	hold time LOW	nDn to nCP; see Fig. 6	0.1	-0.5	-	ns
		nCE to nCP; see Fig. 6	1.0	-0.1	-	ns

18-bit bus-interface D-type flip-flop with reset and enable; 3-state

Symbol	Parameter	Conditions	T _{amb} =	T _{amb} = −40 °C to +85 °C			
			Min	Typ[1]	Мах		
t _{WH}	pulse width HIGH	nCP; see <u>Fig. 5</u>	2.0	0.8	-	ns	
t _{WL}	pulse width LOW	nCP	3.0	2.1	-	ns	
		nMR; see <u>Fig. 7</u>	2.0	0.8	-	ns	
t _{rec}	recovery time	nMR to nCP; see Fig. 7	2.0	1.3	-	ns	
f _{max}	maximum frequency	CP; see Fig. 5	150	-	-	MHz	
V _{CC} = 3.	3 V ± 0.3 V					_	
t _{PLH}	LOW to HIGH propagation delay	nCP to nQn; see Fig. 5	1.0	2.3	3.1	ns	
t _{PHL}	HIGH-to-LOW propagation delay	nCP to nQn; see Fig. 5	1.0	2.1	2.9	ns	
		nMR to nQn; see <u>Fig. 7</u>	1.0	2.3	2.9	ns	
t _{PZH}	OFF-state to HIGH propagation delay	nOE to nQn; see Fig. 8	1.7	2.7	4.0	ns	
t _{PZL}	OFF-state to LOW propagation delay	n OE to nQn; see <u>Fig. 8</u>	1.4	2.3	3.5	ns	
t _{PHZ}	HIGH to OFF-state propagation delay	nOE to nQn; see Fig. 8	2.2	3.1	4.0	ns	
t _{PLZ}	LOW to OFF-state propagation delay	n OE to nQn; see <u>Fig. 8</u>	1.8	2.6	3.5	ns	
t _{su(H)}	set-up time HIGH	nDn to nCP; see Fig. 6	1.0	0.5	-	ns	
		nCE to nCP; see Fig. 6	1.0	0.1	-	ns	
t _{su(L)}	set-up time LOW	nDn to nCP; see Fig. 6	1.6	1.1	-	ns	
		nCE to nCP; see Fig. 6	0.5	-0.5	-	ns	
t _{h(H)}	hold time HIGH	nDn to nCP; see Fig. 6	0.1	-0.7	-	ns	
		nCE to nCP; see Fig. 6	1.0	0.5	-	ns	
t _{h(L)}	hold time LOW	nDn to nCP; see Fig. 6	0.1	-0.5	-	ns	
		nCE to nCP; see Fig. 6	1.0	-0.1	-	ns	
t _{WH}	pulse width HIGH	nCP; see Fig. 5	1.5	0.7	-	ns	
t _{WL}	pulse width LOW	nCP	2.5	1.4	-	ns	
		nMR; see <u>Fig. 7</u>	2.0	1.5	-	ns	
t _{rec}	recovery time	nMR to nCP; see <u>Fig. 7</u>	2.0	1.1	-	ns	
f _{max}	maximum frequency	CP; see Fig. 5	250	-	-	MHz	

[1] All typical values for V_{CC} = 2.5 V ± 0.2 V are measured at V_{CC} = 2.5 V and T_{amb} = 25 °C. All typical values for V_{CC} = 3.3 V ± 0.3 V are measured at V_{CC} = 3.3 V and T_{amb} = 25 °C.

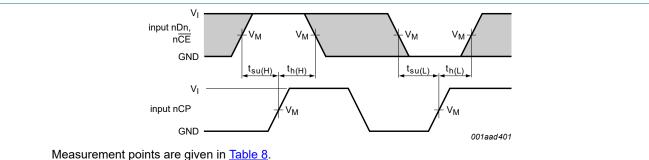
10.1. Waveforms and test circuit



Measurement points are given in Table 8.

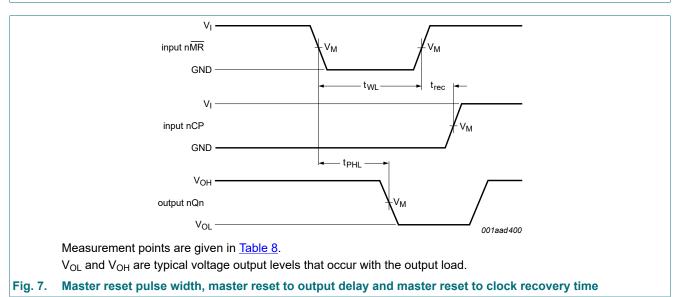
 V_{OL} and V_{OH} are typical voltage output levels that occur with the output load.

Fig. 5. Propagation delay clock input (nCP) to output (nQn), clock pulse (nCP) width HIGH and maximum clock frequency



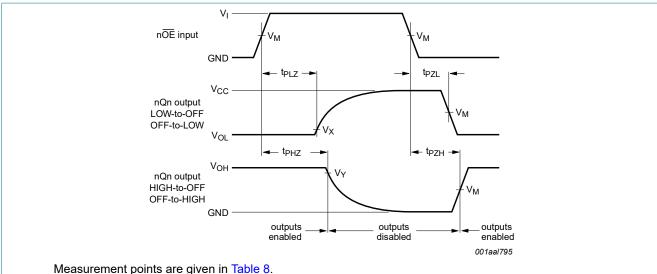
The shaded areas indicate when the input is permitted to change for predictable output performance.

Fig. 6. Data set-up and hold times



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18-bit bus-interface D-type flip-flop with reset and enable; 3-state



Measurement points are given in <u>Table 8</u>.

V_{OL} and V_{OH} are typical voltage output levels that occur with the output load.

Fig. 8. OFF-state to HIGH and LOW propagation delays and LOW and HIGH to OFF-state propagation delays

Table	8.	Measurement	points
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V _{cc}	Input	Output			
	V _M	V _M	V _X	V _Y	
≤ 2.7 V	0.5 x V _{CC}	0.5 x V _{CC}	V _{OL} + 0.15 V	V _{OH} - 0.15 V	
≥ 3.0 V	1.5 V	1.5 V	V _{OL} + 0.3 V	V _{OH} - 0.3 V	

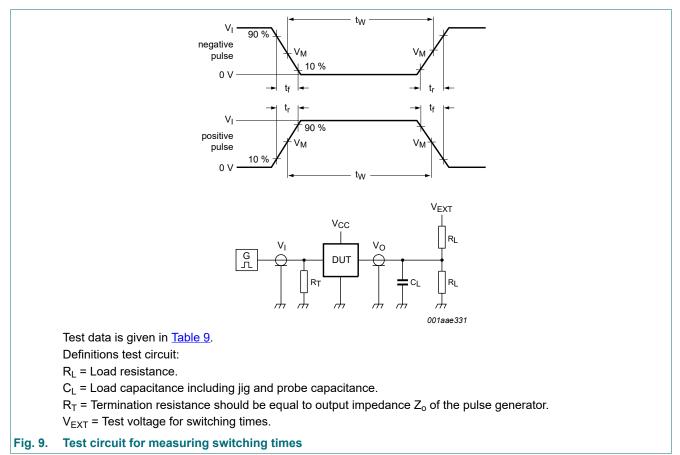


Table 9. Test data

Input			Load		V _{EXT}			
VI	f _i	tw	t _r , t _f	CL	RL	t _{PHZ} , t _{PZH}	t _{PLZ} , t _{PZL}	t _{PLH} , t _{PHL}
3.0 V or V_{CC} whichever is less	≤ 10 MHz	500 ns	≤ 2.5 ns	50 pF	500 Ω	GND	6 V or V _{CC} × 2	open

11. Package outline

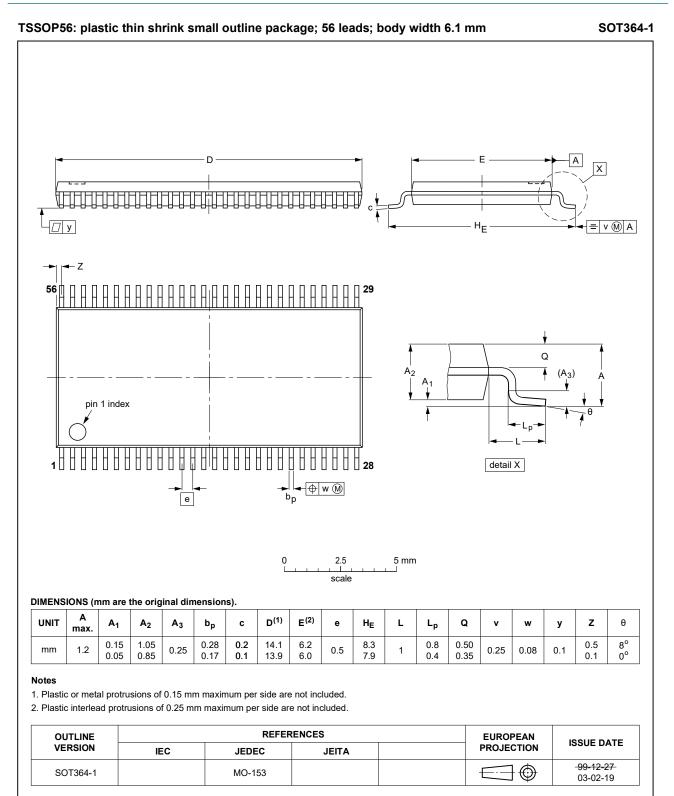


Fig. 10. Package outline SOT364-1 (TSSOP56)

74ALVT16823

12. Abbreviations

Acronym	Description
BiCMOS	Bipolar Complementary Metal Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
MIL	Military
MM	Machine Model
MOS	Metal-Oxide Semiconductor
TTL	Transistor-Transistor Logic

13. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes		
74ALVT16823 v.6	20201020	Product data sheet	-	74ALVT16823 v.5		
Modifications:		 Type number 74ALVT16823DL (SOT371-1 / SSOP56) removed. <u>Section 1</u> and <u>Section 2</u> updated. 				
74ALVT16823 v.5	20180122	Product data sheet	-	74ALVT16823 v.4		
Modifications:	guidelines	 The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia. Legal texts have been adapted to the new company name where appropriate. 				
74ALVT16823 v.4	20050802	Product data sheet	-	74ALVT16823 v.3		
Modifications:	and informa • <u>Section 2</u> : r	and information standard of Philips Semiconductors.				
74ALVT16823 v.3	19980612	Product specification	-	74ALVT16823 v.2		
74ALVT16823 v.2	19980612	Product specification	-	74ALVT16823 v.1		
74ALVT16823 v.1	19980303	Product specification	-	-		

14. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

 Please consult the most recently issued document before initiating or completing a design.

- [2] The term 'short data sheet' is explained in section "Definitions".
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the internet at <u>https://www.nexperia.com</u>.

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